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**AMENDMENTS TO THE CLAIMS** 

This listing of claims will replace all prior versions and listings of claims in the

application:

LISTING OF CLAIMS:

1. (currently amended): A gallium nitride compound semiconductor light-emitting device

comprising:

a crystalline substrate (10);

a light-emitting layer (15) of a quantum well structure which-that is formed of a gallium

nitride compound semiconductor barrier layer doped with an impurity element and a gallium

nitride compound semiconductor well layer undoped with any impurity element, which said

light-emitting layer isbeing provided on a second side of the crystalline substrate;

a contact layer (17) formed of a Group III-V compound semiconductor for providing an

Ohmic electrode for supplying device operation current to the light-emitting layer; and

an Ohmic electrode (18) which that is provided on the contact layer and has an aperture

through which a portion of the contact layer is exposed.

wherein the Ohmic electrode exhibits light permeability with respect to light emitted

from the light-emitting layer, and the well layer contains a thick portion having a large thickness

and a thin portion having a small thickness.

2. (original): A gallium nitride compound semiconductor light-emitting device according to

claim 1, wherein the well layer contains a portion having a thickness of 1.5 nm to 0 nm.

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Claims 3 - 4 (canceled).

5. (original): A gallium nitride compound semiconductor light-emitting device according to

claim 4, wherein the predetermined impurity element added only to the barrier layer is silicon.

6. (previously presented): A gallium nitride compound semiconductor light-emitting device

according to claim 1, wherein the contact layer (17) is doped with an n-type impurity element

and has a carrier concentration of  $5 \times 10^{18}$  cm<sup>-3</sup> to  $2 \times 10^{19}$  cm<sup>-3</sup>.

7. (previously presented): A gallium nitride compound semiconductor light-emitting device

according to claim 1, wherein the contact layer (17) is doped with a p-type impurity element and

has a carrier concentration of  $1 \times 10^{17}$  cm<sup>-3</sup> to  $1 \times 10^{19}$  cm<sup>-3</sup>.

8. (original): A gallium nitride compound semiconductor light-emitting device according to

claim 7, wherein the contact layer (17) is doped with a p-type impurity element and has a carrier

concentration of  $1 \times 10^{17}$  cm<sup>-3</sup> to  $5 \times 10^{18}$  cm<sup>-3</sup>.

9. (previously presented): A gallium nitride compound semiconductor light-emitting device

according to claim 1, wherein the contact layer (17) has a thickness of 1 µm to 3 µm.

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10. (previously presented): A gallium nitride compound semiconductor light-emitting device

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according to claim 1, wherein the Ohmic electrode (18) exhibits a transmittance at the

wavelength of emitted light of 30% or higher.

11. (previously presented): A gallium nitride compound semiconductor light-emitting device

according to claim 1, wherein the Ohmic electrode (18) has a thickness of 1 nm to 100 nm.

12. (previously presented): A gallium nitride compound semiconductor light-emitting device

according to claim 1, further comprising a metallic reflecting mirror (21) for reflecting light

emitted from the light-emitting layer (15) to the outside, which mirror is provided on a first side

of the crystalline substrate (10), wherein the metallic reflecting mirror (21) contains a metallic

material identical to that contained in the Ohmic electrode (18).

13. (original): A gallium nitride compound semiconductor light-emitting device according to

claim 12, wherein the metallic reflecting mirror (18) has a multilayer structure including a

metallic film which contains a metallic material identical to that contained in the Ohmic

electrode (18).

14. (previously presented): A gallium nitride compound semiconductor light-emitting device

according to claim 1, wherein the metallic reflecting mirror (21) contains a single-metal film or

an alloy film formed from at least one member selected from the group consisting of silver,

platinum, rhodium and aluminum.

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15. (previously presented): A gallium nitride compound semiconductor light-emitting device

according to claim 1, wherein the metallic reflecting mirror (21) is in the form of multilayer film.

16. (previously presented): A light-emitting diode employing the gallium nitride compound

semiconductor light-emitting device according to claim 1.

17. (previously presented): A lamp employing the gallium nitride compound semiconductor

light-emitting device according to claim 1.

18. (new): A gallium nitride compound semiconductor light-emitting device according to claim

1, wherein the barrier layer is a barrier layer which is doped with a Group IV element at an

average atom density of 1 x  $10^{17}$  cm<sup>-3</sup> to 5 x  $10^{18}$  cm<sup>-3</sup> and which exhibits low resistance.

19. (new): A gallium nitride compound semiconductor light-emitting device according to claim

1, wherein the barrier layer is an Si-doped n-type GaN barrier layer.